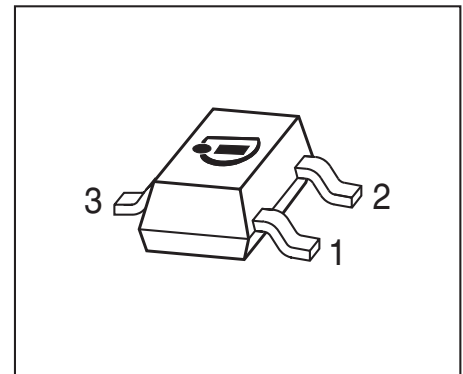


**NPN Silicon High-Voltage Transistors**

- Suitable for video output stages in TV sets and switching power supplies
- High breakdown voltage
- Low collector-emitter saturation voltage
- Complementary type: BFN27 (PNP)
- Pb-free (RoHS compliant) package
- Qualified according AEC Q101



| Type  | Marking | Pin Configuration |     |     | Package |
|-------|---------|-------------------|-----|-----|---------|
|       |         | 1=B               | 2=E | 3=C |         |
| BFN24 | FHs     | 1=B               | 2=E | 3=C | SOT23   |
| BFN26 | FJs     | 1=B               | 2=E | 3=C | SOT23   |

**Maximum Ratings**

| Parameter                                    | Symbol    | Value       | Unit |
|--|-----------|-------------|------|
| Collector-emitter voltage                    | $V_{CEO}$ |             | V    |
| BFN24  |           | 250         |      |
| BFN26  |           | 300         |      |
| Collector-base voltage                       | $V_{CBO}$ |             |      |
| BFN24  |           | 250         |      |
| BFN26  |           | 300         |      |
| Emitter-base voltage                         | $V_{EBO}$ | 6           |      |
| Collector current                            | $I_C$     | 200         | mA   |
| Peak collector current, $t_p \leq 10$ ms     | $I_{CM}$  | 500         |      |
| Base current                                 | $I_B$     | 100         |      |
| Peak base current                            | $I_{BM}$  | 200         |      |
| Total power dissipation-<br>$T_S \leq 74$ °C | $P_{tot}$ | 360         | mW   |
| Junction temperature                         | $T_j$     | 150         | °C   |
| Storage temperature                          | $T_{stg}$ | -65 ... 150 |      |

**Thermal Resistance**

| Parameter                                | Symbol     | Value      | Unit |
|--|------------|------------|------|
| Junction - soldering point <sup>1)</sup> | $R_{thJS}$ | $\leq 210$ | K/W  |

**Electrical Characteristics at  $T_A = 25^\circ\text{C}$ , unless otherwise specified**

| Parameter | Symbol | Values |      |      | Unit |
|-----------|--------|--------|------|------|------|
|           |        | min.   | typ. | max. |      |

**DC Characteristics**

|   |               |                      |                  |                        |               |
|---|---------------|----------------------|------------------|------------------------|---------------|
| Collector-emitter breakdown voltage<br>$I_C = 1\text{ mA}$ , $I_B = 0$ , BFN24<br>$I_C = 1\text{ mA}$ , $I_B = 0$ , BFN26   | $V_{(BR)CEO}$ | 250<br>300           | -<br>-           | -<br>-                 | V             |
| Collector-base breakdown voltage<br>$I_C = 100\ \mu\text{A}$ , $I_E = 0$ , BFN24<br>$I_C = 100\ \mu\text{A}$ , $I_E = 0$ , BFN26  | $V_{(BR)CBO}$ | 250<br>300           | -<br>-           | -<br>-                 |               |
| Emitter-base breakdown voltage<br>$I_E = 100\ \mu\text{A}$ , $I_C = 0$  | $V_{(BR)EBO}$ | 6                    | -                | -                      |               |
| Collector-base cutoff current<br>$V_{CB} = 200\text{ V}$ , $I_E = 0$ , BFN24<br>$V_{CB} = 250\text{ V}$ , $I_E = 0$ , BFN26<br>$V_{CB} = 200\text{ V}$ , $I_E = 0$ , $T_A = 150^\circ\text{C}$ , BFN24<br>$V_{CB} = 250\text{ V}$ , $I_E = 0$ , $T_A = 150^\circ\text{C}$ , BFN26 | $I_{CBO}$     | -<br>-<br>-<br>-     | -<br>-<br>-<br>- | 0.1<br>0.1<br>20<br>20 | $\mu\text{A}$ |
| Emitter-base cutoff current<br>$V_{EB} = 5\text{ V}$ , $I_C = 0$  | $I_{EBO}$     | -                    | -                | 100                    | nA            |
| DC current gain <sup>2)</sup><br>$I_C = 1\text{ mA}$ , $V_{CE} = 10\text{ V}$<br>$I_C = 10\text{ mA}$ , $V_{CE} = 10\text{ V}$<br>$I_C = 30\text{ mA}$ , $V_{CE} = 10\text{ V}$ , BFN24<br>$I_C = 30\text{ mA}$ , $V_{CE} = 10\text{ V}$ , BFN26                                  | $h_{FE}$      | 25<br>40<br>40<br>30 | -<br>-<br>-<br>- | -<br>-<br>-<br>-       | -             |
| Collector-emitter saturation voltage <sup>2)</sup><br>$I_C = 20\text{ mA}$ , $I_B = 2\text{ mA}$ , BFN24<br>$I_C = 20\text{ mA}$ , $I_B = 2\text{ mA}$ , BFN26  | $V_{CEsat}$   | -<br>-               | -<br>-           | 0.4<br>0.5             | V             |
| Base emitter saturation voltage <sup>2)</sup><br>$I_C = 20\text{ mA}$ , $I_B = 2\text{ mA}$   | $V_{BEsat}$   | -                    | -                | 0.9                    |               |

<sup>1)</sup>For calculation of  $R_{thJA}$  please refer to Application Note AN077 (Thermal Resistance Calculation)

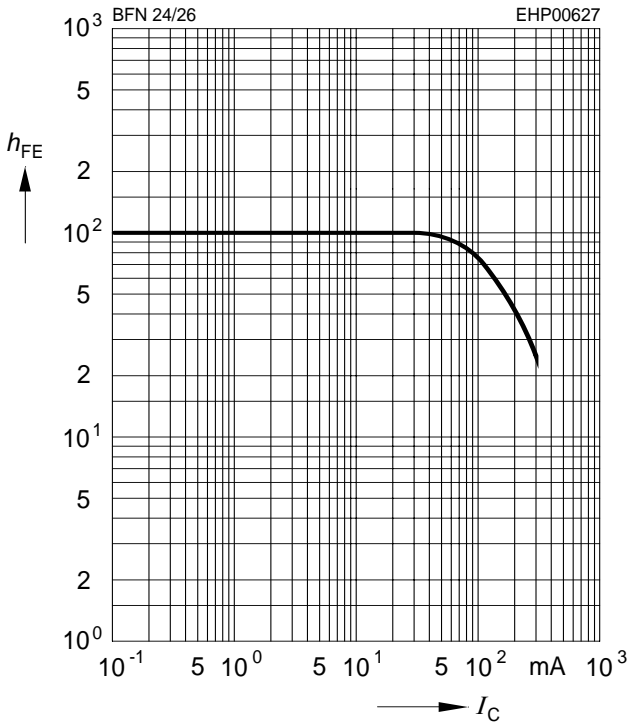
<sup>2)</sup>Pulse test:  $t < 300\ \mu\text{s}$ ;  $D < 2\%$

**Electrical Characteristics** at  $T_A = 25^\circ\text{C}$ , unless otherwise specified

| Parameter   | Symbol   | Values |      |      | Unit |
|---|----------|--------|------|------|------|
|   |          | min.   | typ. | max. |      |
| <b>AC Characteristics</b>   |          |        |      |      |      |
| Transition frequency<br>$I_C = 20\text{ mA}$ , $V_{CE} = 10\text{ V}$ , $f = 20\text{ MHz}$ | $f_T$    | -      | 70   | -    | MHz  |
| Collector-base capacitance<br>$V_{CB} = 30\text{ V}$ , $f = 1\text{ MHz}$                   | $C_{cb}$ | -      | 1.5  | -    | pF   |

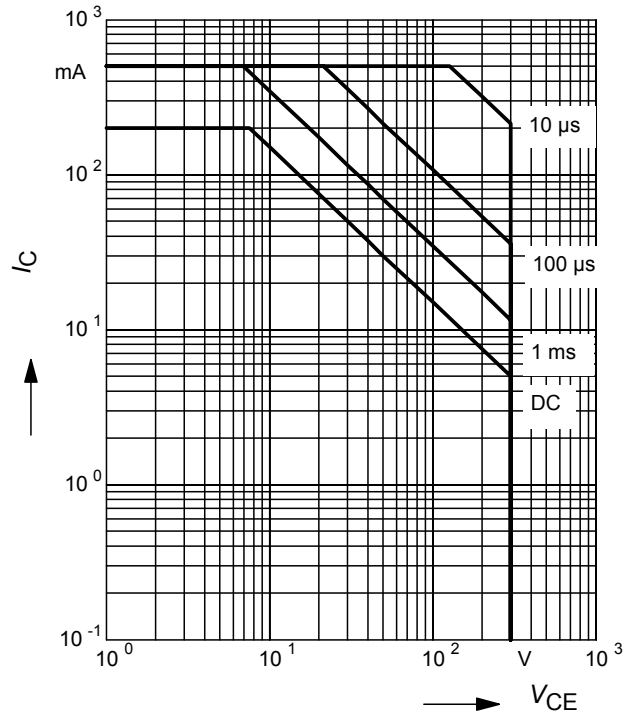
**DC current gain  $h_{FE} = f(I_C)$**

$V_{CE} = 10\text{ V}$



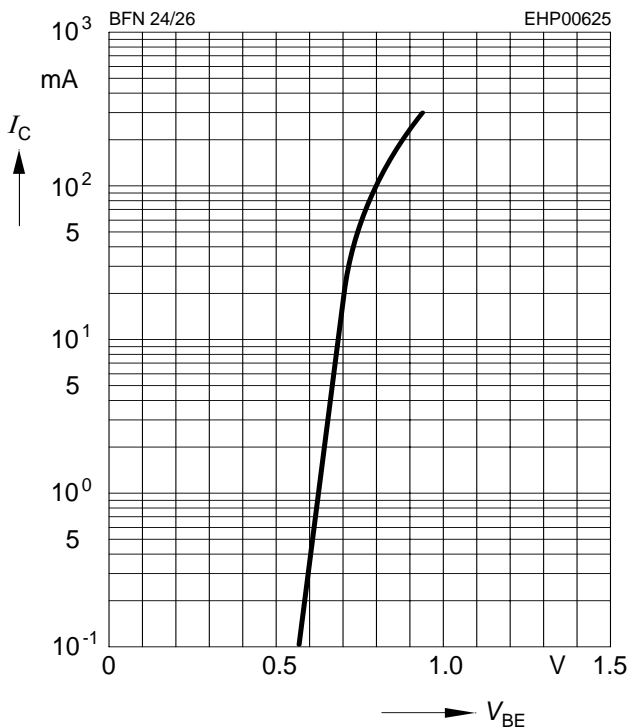
**Operating range  $I_C = f(V_{CE0})$**

$T_A = 25^\circ\text{C}, D = 0$



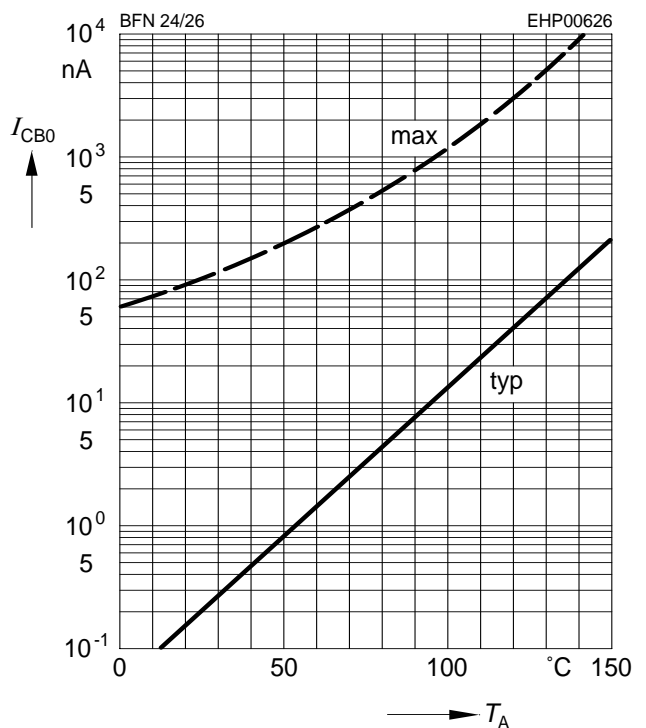
**Collector current  $I_C = f(V_{BE})$**

$V_{CE} = 10\text{ V}$



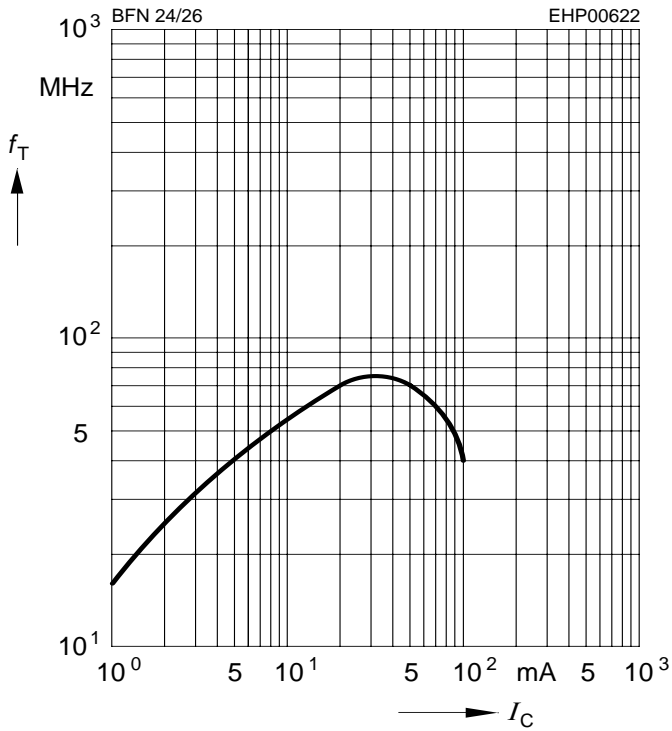
**Collector cutoff current  $I_{CBO} = f(T_A)$**

$V_{CB} = 200\text{ V}$



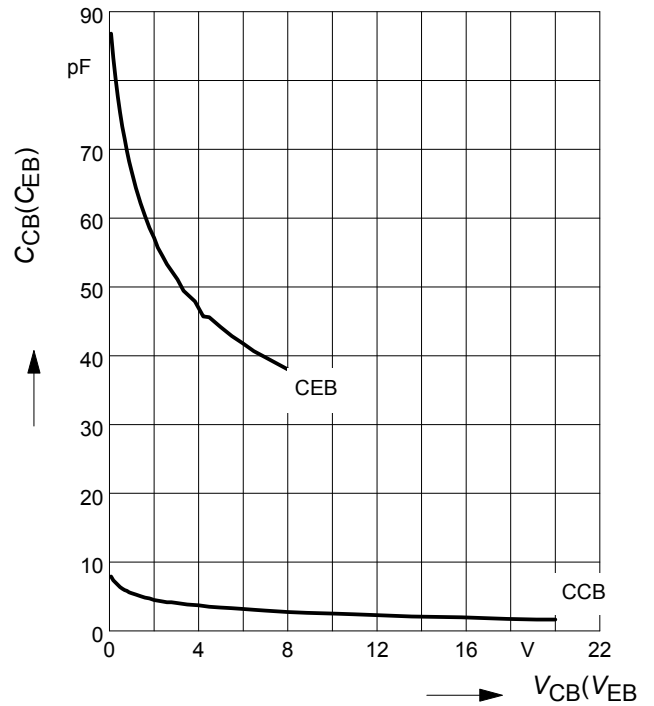
Transition frequency  $f_T = f(I_C)$

$V_{CE}$  = parameter in V,  $f = 2$  GHz

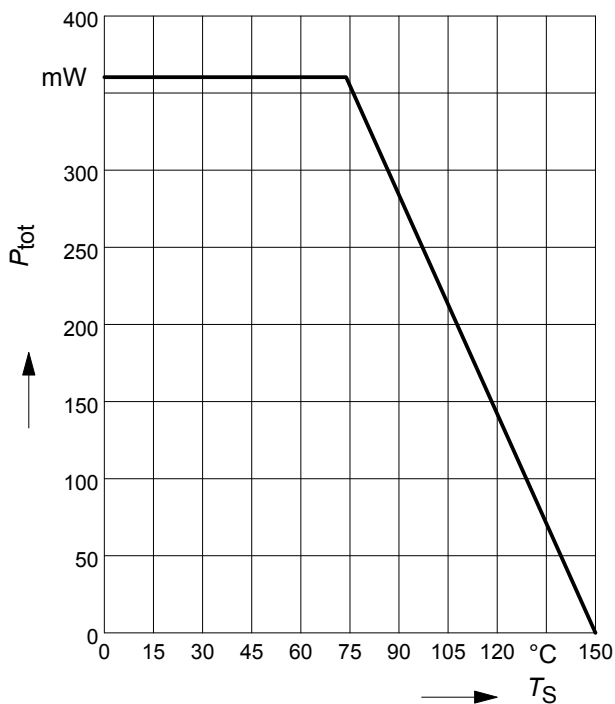


Collector-base capacitance  $C_{cb} = f(V_{CB})$

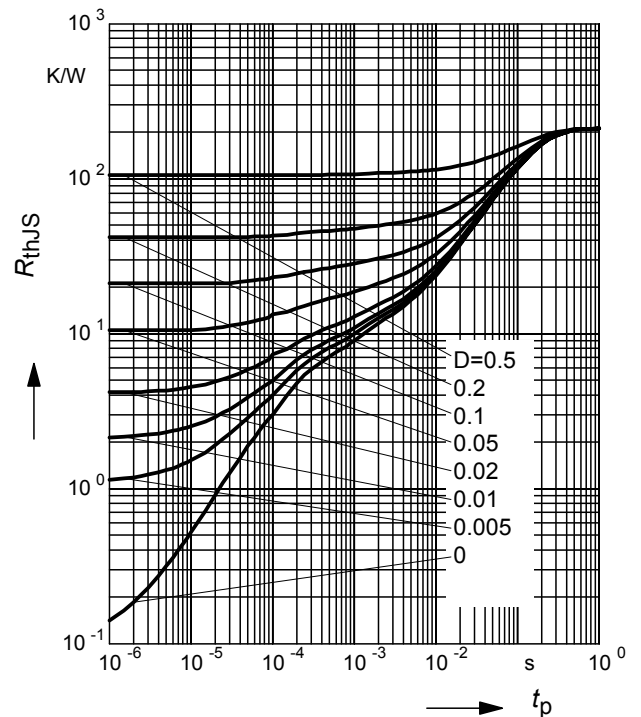
Emitter-base capacitance  $C_{eb} = f(V_{EB})$



Total power dissipation  $P_{tot} = f(T_S)$

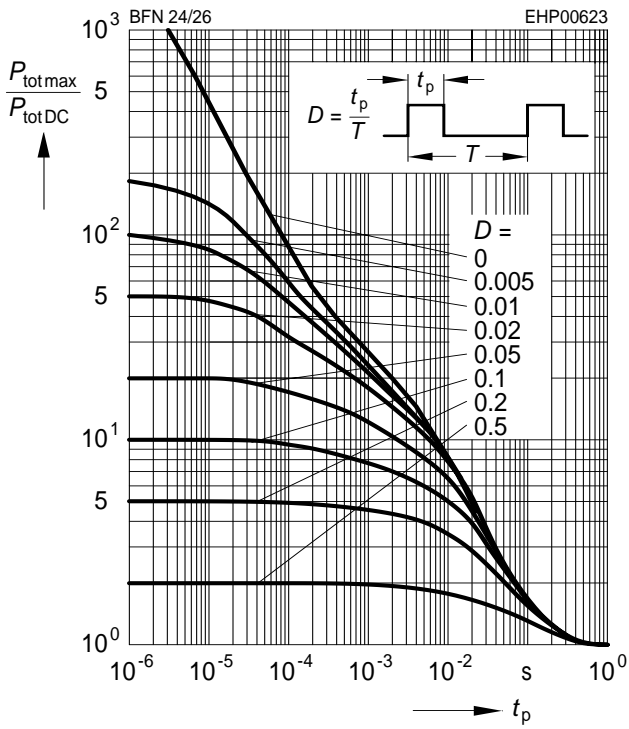


Permissible Pulse Load  $R_{thJS} = f(t_p)$

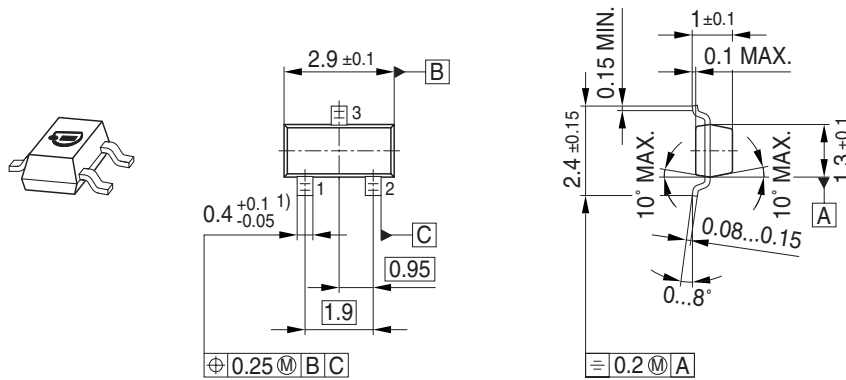


**Permissible Pulse Load**

$$P_{\text{totmax}}/P_{\text{totDC}} = f(t_p)$$

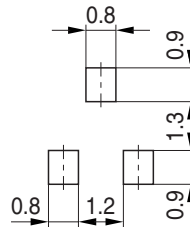


Package Outline

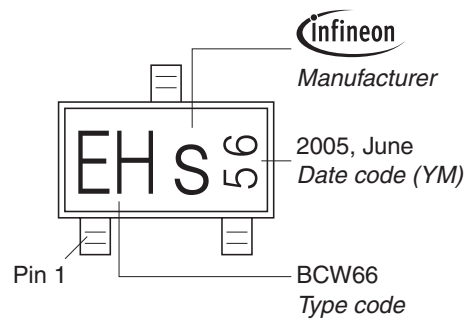


1) Lead width can be 0.6 max. in dambar area

Foot Print

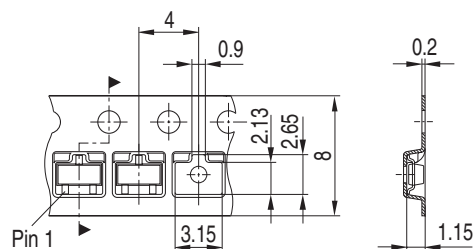


Marking Layout (Example)



Standard Packing

Reel  $\varnothing$ 180 mm = 3.000 Pieces/Reel  
 Reel  $\varnothing$ 330 mm = 10.000 Pieces/Reel



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